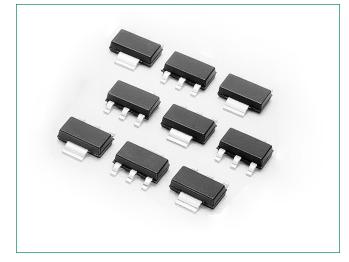


MAC08BT1, MAC08MT1



Description

Designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

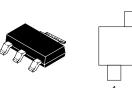
Features

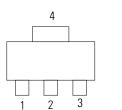
- Sensitive Gate Trigger Current in Four Trigger Modes
- Blocking Voltage to 600 Volts
- Glass Passivated Surface for Reliability and Uniformity
- Surface Mount Package

Po

• Pb–Free Packages are Available

Pin Out





Functional Diagram

Additional Information







Samples



Maximum Ratings (T_j = 25°C unless otherwise noted)

C 1				
Rating		Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, $T_{_J} = -40^{\circ}$ to 110°C)	MAC08BT1 MAC08MT1	V _{drm} , V _{rrm}	200 600	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_c = 80^{\circ}$ C)	I _{T (RMS)}	0.8	А	
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _c = 25°C)	I _{TSM}	8.0	А	
Circuit Fusing Consideration (t = 8.3 msec)	l ² t	0.4	A ² sec	
Peak Gate Power (Pulse Width \leq 10 µsec, T _c = 80°C)	P _{GM}	5.0	W	
Average Gate Power (t = 8.3 msec, T_c = 80°C)	P _{G(AV)}	0.1	W	
Operating Junction Temperature Range	T	-40 to +110	°C	
Storage Temperature Range		T _{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Batings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics			
Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient PCB Mounted per Figure 1	R _{8JA}	156	°C/W

2. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

3. 1/8" from case for 10 seconds.

Electrical Characteristics - OFF ($T_c = 25^{\circ}C$ unless otherwise noted)							
Characteristic		Symbol	Min	Тур	Мах	Unit	
†Peak Repetitive Blocking Current	T_ = 25°C	I _{DRM} ,	-	-	10	μA	
$(V_{AK} = V_{DRM} = V_{RRM}; \text{ Gate Open})$	T _J = 110°C	I _{RRM}	-	-	200	mA	

Electrical Characteristics - **ON** ($T_c = 25^{\circ}$ C unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak On–State Voltage (Note 2) ($I_{TM} = \pm 1.1 \text{ A}$)	V _{TM}	-	-	1.9	V
Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega)$	I _{gt}	-	-	10	mA
Holding Current ($V_p = 12 V$, Gate Open, Initiating Current = ±20 mA))	I _H	-	-	5.0	mA
Gate Trigger Voltage (Continuous dc) (V_{_{D}} = 12 V, R $_{_{L}}$ = 100 $\Omega)$	V _{gt}	-	-	2.0	V

2. Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Dynamic Characteristics

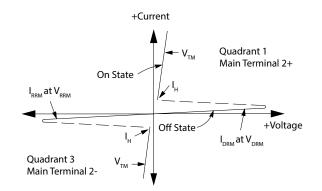
Characteristic	Symbol	Min	Тур	Мах	Unit
Critical Rate of Rise of Commutation Voltage (f = 250 Hz, I _{TM} = 1.0 A, Commutating di/dt = 1.5 A/mS On–State Current Duration = 2.0 mS, V _{DRM} = 200 V, Gate Unenergized, T _c = 110°C, Gate Source Resistance = 150 Ω , See Figure 10)	(dl/dt)c	1.5	_	_	A/ms
Critical Rate of Rise of Off-State Voltage ($V_D = 0.67 \times V_{DRM}$, Exponential Waveform, Gate Open, $T_J = 110^{\circ}$ C)	dV/dt	10	-	-	V/µs



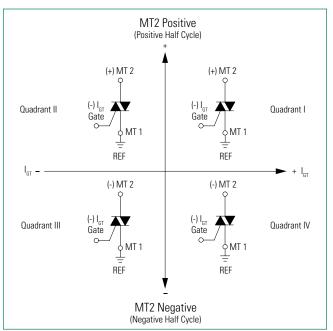
Voltage Current Characteristic of SCR

Quadrant Definitions for a Triac

Symbol	Parameter			
V _{DRM}	Peak Repetitive Forward Off State Voltage			
I _{DRM}	Peak Forward Blocking Current			
V _{RRM}	Peak Repetitive Reverse Off State Voltage			
I _{RRM}	Peak Reverse Blocking Current			
V _{TM}	Maximum On State Voltage			
I _H	Holding Current			



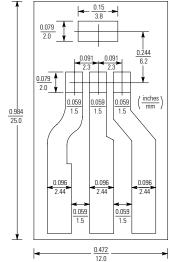
of SOT-223



All Polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used

Figure 1. PCB for Thermal Impedance and Power Testing



BOARD MOUNTED VERTICALLY IN CINCH 8840 EDGE CONNECTOR. BOARD THICKNESS = 65 MIL., FOIL THICKNESS = 2.5 MIL. MATERIAL: G10 FIBERGLASS BASE EPOXY



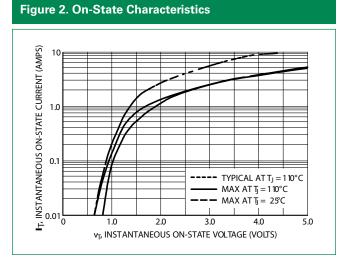


Figure 4. Current Derating, Minimum Pad Size Reference: Ambient Temperature

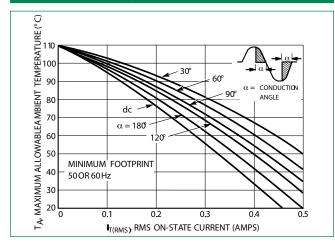


Figure 6. Current Derating, 2.0 cm Square Pad Reference: Ambient Temperature

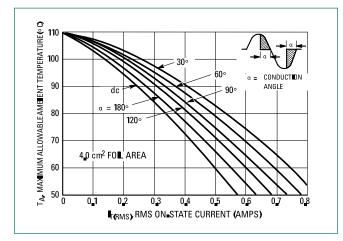


Figure 3. Junction to Ambient Thermal Resistance vs.

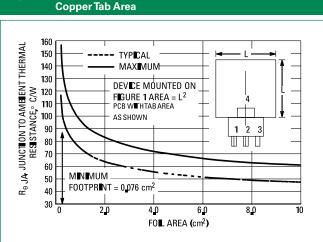


Figure 5. Current Derating, 1.0 cm Square Pad Reference: Ambient Temperature

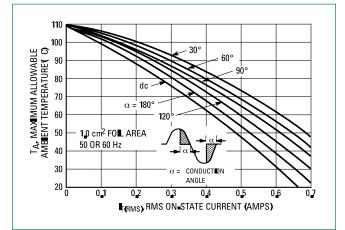
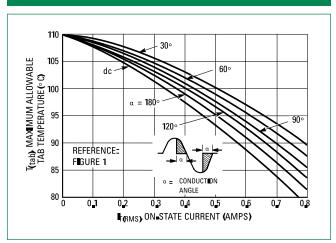


Figure 7. Current Derating Reference: MT2 Tab





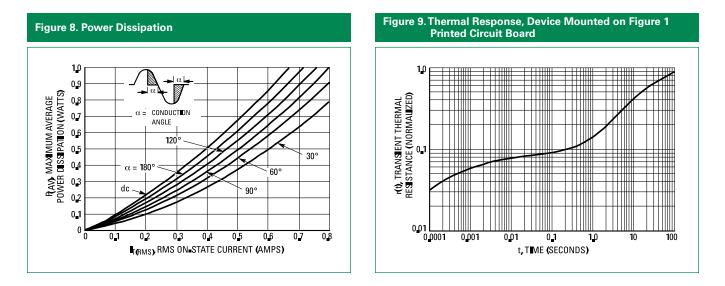
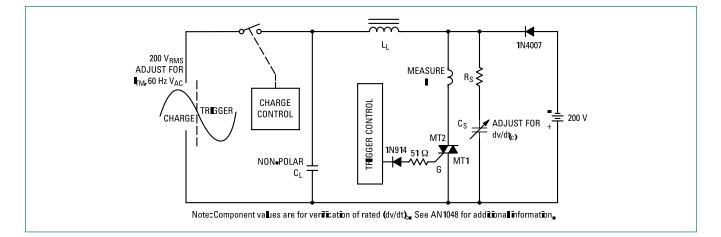


Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)



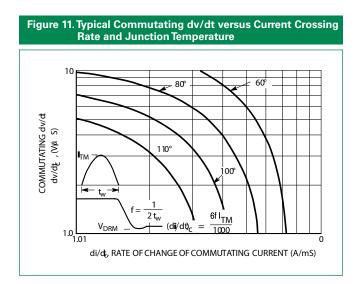
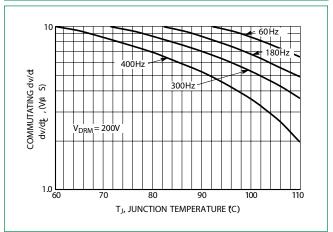


Figure 12. Typical Commutating dv/dt versus Junction Temperature at 0.8 Amps RMS





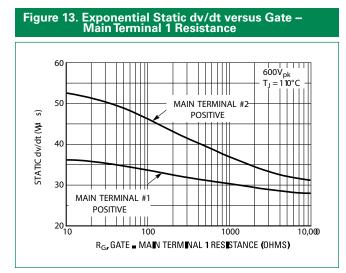


Figure 15. Typical Holding Current Variation

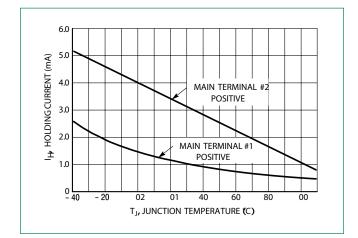


Figure 14. Typical Gate Trigger Current Variation

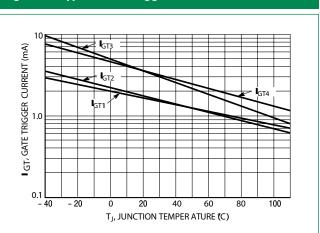
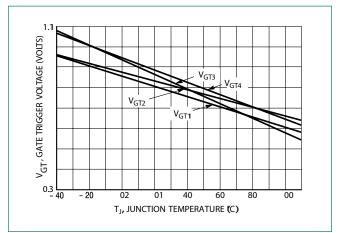
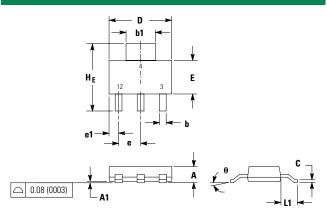


Figure 16. Gate Trigger Voltage Variation



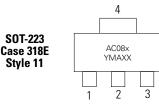


Dimensions



Part Marking System

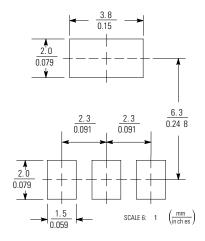




AC08X	=Device Code
х	=D, M, or N
Y	=Year
M	=Month
A	=Assembly Site
XX	=Lot Serial Code
G	=Pb-Free Package

Dim	Inches			Millimeters				
Dim	Min	Nom	Max	Min	Nom	Max		
Α			0.071			1.80		
A1	0.001	0.003	0.005	0.02	0.07	0.13		
b	0.026	0.030	0.033	0.66	0.75	0.84		
b1	0.114	0.118	0.122	2.90	3.00	3.10		
c	0.009	0.011	0.014	0.23	0.29	0.35		
D	0.260	0.260	0.264	6.60	6.60	6.71		
Е	0.130	0.138	0.146	3.30	3.50	3.70		
е		0.091			2.30			
e1	0.030	0.037	0.045	0.75	0.95	1.15		
L1	0.059	0.069	0.079	1.50	1.75	2.00		
HE	0.268	0.276	0.283	6.80	7.00	7.20		
ø	0°		10°	0°		10°		

Soldering Footprint



1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

Pin Assignment				
1	Main Terminal 1			
2	Main Terminal 2			
3	Gate			
4	Main Terminal 2			

Ordering Information

Device	Package Type	Shipping
MAC08BT1	SOT-223	1000 / Tape & Reel
MAC08BT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel
MAC08MT1	SOT-223	1000 / Tape & Reel
MAC08MT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel

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